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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	EBI/EMI, I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	70
Program Memory Size	16KB (8K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	768 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-TQFP
Supplier Device Package	80-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf8410-i-pt

3.4 RC Oscillator

For timing-insensitive applications, the "RC" and "RCIO" device options offer additional cost savings. The actual oscillator frequency is a function of several factors:

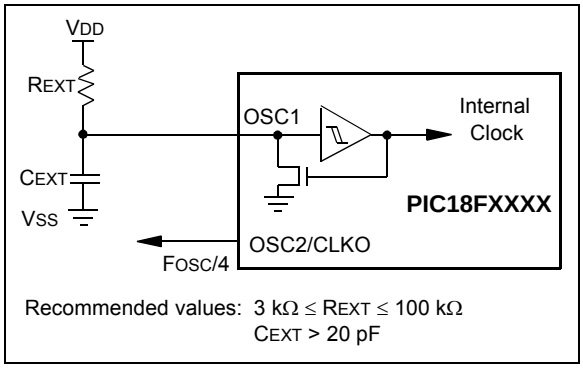
- Supply voltage
- Values of the external resistor (REXT) and capacitor (CEXT)
- Operating temperature

Given the same device, operating voltage and temperature and component values, there will also be unit-to-unit frequency variations. These are due to factors such as:

- Normal manufacturing variation
- Difference in lead frame capacitance between package types (especially for low CEXT values)
- Variations within the tolerance of limits of REXT and CEXT

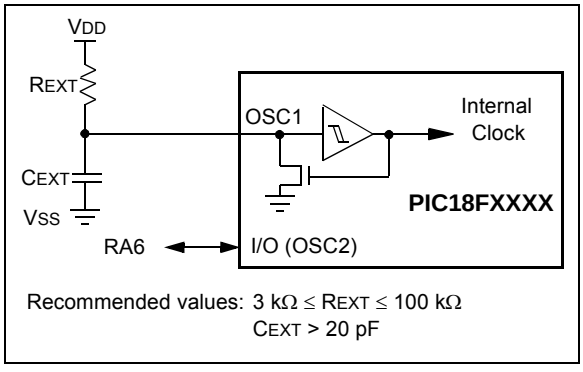
In the RC Oscillator mode, the oscillator frequency divided by 4 is available on the OSC2 pin. This signal may be used for test purposes or to synchronize other logic. Figure 3-5 shows how the R/C combination is connected.

FIGURE 3-5: RC OSCILLATOR MODE



The RCIO Oscillator mode (Figure 3-6) functions like the RC mode, except that the OSC2 pin becomes an additional general purpose I/O pin. The I/O pin becomes bit 6 of PORTA (RA6).

FIGURE 3-6: RCIO OSCILLATOR MODE



3.5 PLL Frequency Multiplier

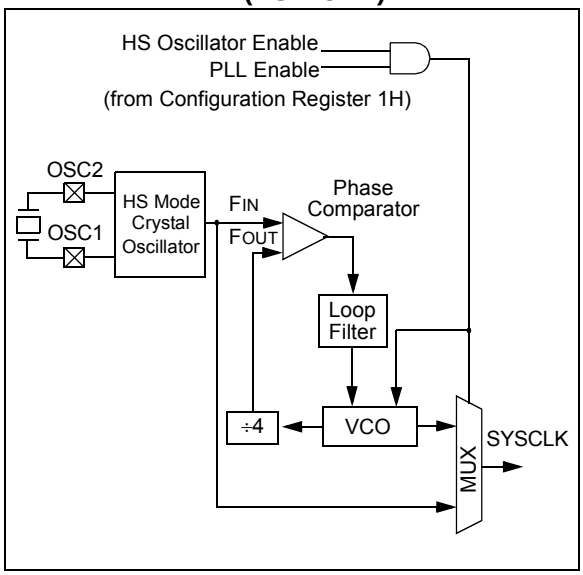
A Phase Locked Loop (PLL) circuit is provided as an option for users who want to use a lower frequency oscillator circuit, or to clock the device up to its highest rated frequency from a crystal oscillator. This may be useful for customers who are concerned with EMI due to high-frequency crystals, or users who require higher clock speeds from an internal oscillator.

3.5.1 HSPLL OSCILLATOR MODE

The HSPLL mode makes use of the HS Oscillator mode for frequencies up to 10 MHz. A PLL then multiplies the oscillator output frequency by 4 to produce an internal clock frequency up to 40 MHz.

The PLL is only available to the crystal oscillator when the FOSC<3:0> Configuration bits are programmed for HSPLL mode (= 0110).

FIGURE 3-7: PLL BLOCK DIAGRAM (HS MODE)



3.5.2 PLL AND INTOSC

The PLL is also available to the internal oscillator block in selected oscillator modes. In this configuration, the PLL is enabled in software and generates a clock output of up to 32 MHz. The operation of INTOSC with the PLL is described in **Section 3.6.4 "PLL in INTOSC Modes"**.

4.2.3 RC_RUN MODE

In RC_RUN mode, the CPU and peripherals are clocked from the internal oscillator block using the INTOSC multiplexer and the primary clock is shut down. When using the INTRC source, this mode provides the best power conservation of all the Run modes, while still executing code. It works well for user applications which are not highly timing-sensitive, or do not require high-speed clocks at all times.

If the primary clock source is the internal oscillator block (either INTRC or INTOSC), there are no distinguishable differences between PRI_RUN and RC_RUN modes during execution. However, a clock switch delay will occur during entry to and exit from RC_RUN mode. Therefore, if the primary clock source is the internal oscillator block, the use of RC_RUN mode is not recommended.

This mode is entered by setting the SCS1 bit to '1'. Although it is ignored, it is recommended that the SCS0 bit also be cleared; this is to maintain software compatibility with future devices. When the clock source is switched to the INTOSC multiplexer (see Figure 4-3), the primary oscillator is shut down and the OSTS bit is cleared.The IRCF bits may be modified at any time to immediately change the clock speed.

Note:	Caution should be used when modifying a single IRCF bit. If V_{DD} is less than 3V, it is possible to select a higher clock speed than is supported by the low V_{DD}. Improper device operation may result if the V_{DD}/F_{OSC} specifications are violated.

If the IRCF bits and the INTSRC bit are all clear, the INTOSC output is not enabled and the IOFS bit will remain clear; there will be no indication of the current clock source. The INTRC source is providing the device clocks.

If the IRCF bits are changed from all clear (thus, enabling the INTOSC output), or if INTSRC is set, the IOFS bit becomes set after the INTOSC output becomes stable. Clocks to the device continue while the INTOSC source stabilizes after an interval of T_{IOBST}.

If the IRCF bits were previously at a non-zero value, or if INTSRC was set before setting SCS1 and the INTOSC source was already stable, the IOFS bit will remain set.

On transitions from RC_RUN mode to PRI_RUN, the device continues to be clocked from the INTOSC multiplexer while the primary clock is started. When the primary clock becomes ready, a clock switch to the primary clock occurs (see Figure 4-4). When the clock switch is complete, the IOFS bit is cleared, the OSTS bit is set and the primary clock is providing the device clock. The IDLEN and SCS bits are not affected by the switch. The INTRC source will continue to run if either the WDT or the Fail-Safe Clock Monitor is enabled.

5.0 RESET

The PIC18F6310/6410/8310/8410 devices differentiate between various kinds of Reset:

a) Power-on Reset (POR)
b) $\overline{\text{MCLR}}$ Reset during normal operation
c) $\overline{\text{MCLR}}$ Reset during power-managed modes
d) Watchdog Timer (WDT) Reset (during execution)
e) Programmable Brown-out Reset (BOR)
f) RESET Instruction
g) Stack Full Reset
h) Stack Underflow Reset

This section discusses Resets generated by $\overline{\text{MCLR}}$, POR and BOR and covers the operation of the various start-up timers. Stack Reset events are covered in **Section 6.1.3.4 "Stack Full and Underflow Resets"**. WDT Resets are covered in **Section 24.2 "Watchdog Timer (WDT)"**.

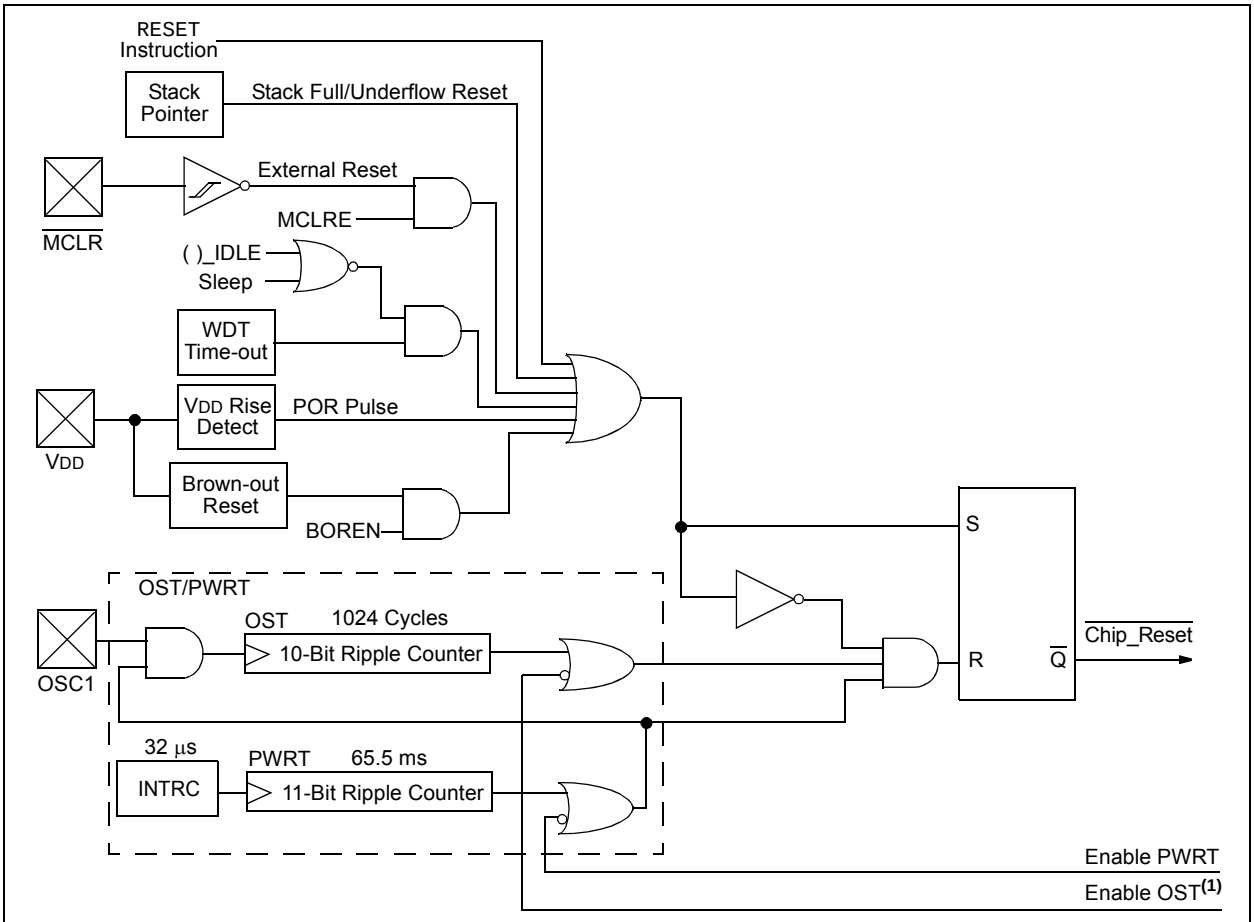
A simplified block diagram of the On-Chip Reset Circuit is shown in Figure 5-1.

5.1 RCON Register

Device Reset events are tracked through the RCON register (Register 5-1). The lower five bits of the register indicate that a specific Reset event has occurred. In most cases, these bits can only be set by the event and must be cleared by the application after the event. The state of these flag bits, taken together, can be read to indicate the type of Reset that just occurred. This is described in more detail in **Section 5.6 "Reset State of Registers"**.

The RCON register also has control bits for setting interrupt priority (IPEN) and software control of the BOR (SBOREN). Interrupt priority is discussed in **Section 10.0 "Interrupts"**. BOR is covered in **Section 5.4 "Brown-out Reset (BOR)"**.

FIGURE 5-1: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



Note 1: See Table 5-2 for time-out situations.

6.1.2 PROGRAM COUNTER

The Program Counter (PC) specifies the address of the instruction to fetch for execution. The PC is 21 bits wide and is contained in three separate 8-bit registers. The low byte, known as the PCL register, is both readable and writable. The high byte, or PCH register, contains the PC<15:8> bits; it is not directly readable or writable. Updates to the PCH register are performed through the PCLATH register. The upper byte is called PCU. This register contains the PC<20:16> bits; it is also not directly readable or writable. Updates to the PCU register are performed through the PCLATU register.

The contents of PCLATH and PCLATU are transferred to the program counter by any operation that writes PCL. Similarly, the upper two bytes of the program counter are transferred to PCLATH and PCLATU by an operation that reads PCL. This is useful for computed offsets to the PC (see **Section 6.1.5.1 "Computed GOTO"**).

The PC addresses bytes in the program memory. To prevent the PC from becoming misaligned with word instructions, the Least Significant bit of PCL is fixed to a value of '0'. The PC increments by 2 to address sequential instructions in the program memory.

The CALL, RCALL, GOTO and program branch instructions write to the program counter directly. For these instructions, the contents of PCLATH and PCLATU are not transferred to the program counter.

6.1.3 RETURN ADDRESS STACK

The Return Address Stack allows any combination of up to 31 program calls and interrupts to occur. The PC is pushed onto the stack when a CALL or RCALL instruction is executed, or an interrupt is Acknowledged. The PC value is pulled off the stack on a RETURN, RETLW or a RETFIE instruction. PCLATU and PCLATH are not affected by any of the RETURN or CALL instructions.

The stack operates as a 31-word by 21-bit RAM and a 5-bit Stack Pointer register, STKPTR. The stack space is not part of either program or data space. The Stack Pointer is readable and writable and the address on the top of the stack is readable and writable through the Top-of-Stack (TOS) Special File Registers. Data can also be pushed to or popped from the stack using these registers.

A CALL type instruction causes a push onto the stack; the Stack Pointer is first incremented and the location pointed to by the Stack Pointer is written with the contents of the PC (already pointing to the instruction following the CALL). A RETURN type instruction causes a pop from the stack; the contents of the location pointed to by the STKPTR are transferred to the PC and then the Stack Pointer is decremented.

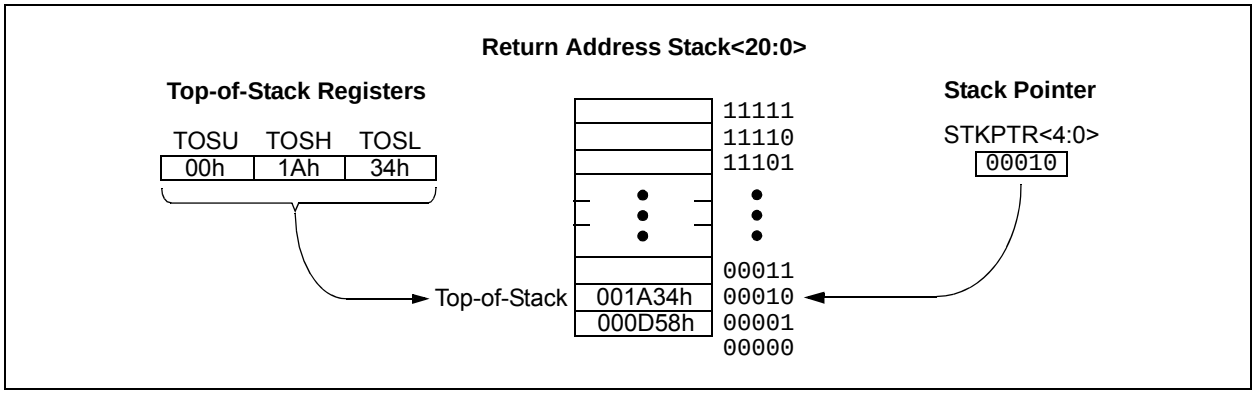
The Stack Pointer is initialized to '00000' after all Resets. There is no RAM associated with the location corresponding to a Stack Pointer value of '00000'; this is only a Reset value. Status bits indicate if the stack is full, has overflowed or has underflowed.

6.1.3.1 Top-of-Stack Access

Only the top of the Return Address Stack (TOS) is readable and writable. A set of three registers, TOSU:TOSH:TOSL, hold the contents of the stack location pointed to by the STKPTR register (Figure 6-3). This allows users to implement a software stack if necessary. After a CALL, RCALL or interrupt, the software can read the pushed value by reading the TOSU:TOSH:TOSL registers. These values can be placed on a user-defined software stack. At return time, the software can return these values to TOSU:TOSH:TOSL and do a return.

The user must disable the global interrupt enable bits while accessing the stack to prevent inadvertent stack corruption.

FIGURE 6-3: RETURN ADDRESS STACK AND ASSOCIATED REGISTERS



8.3 8-Bit Mode

The external memory interface implemented in PIC18F8410 devices operates only in 8-Bit Multiplexed mode; data shares the 8 Least Significant bits of the address bus.

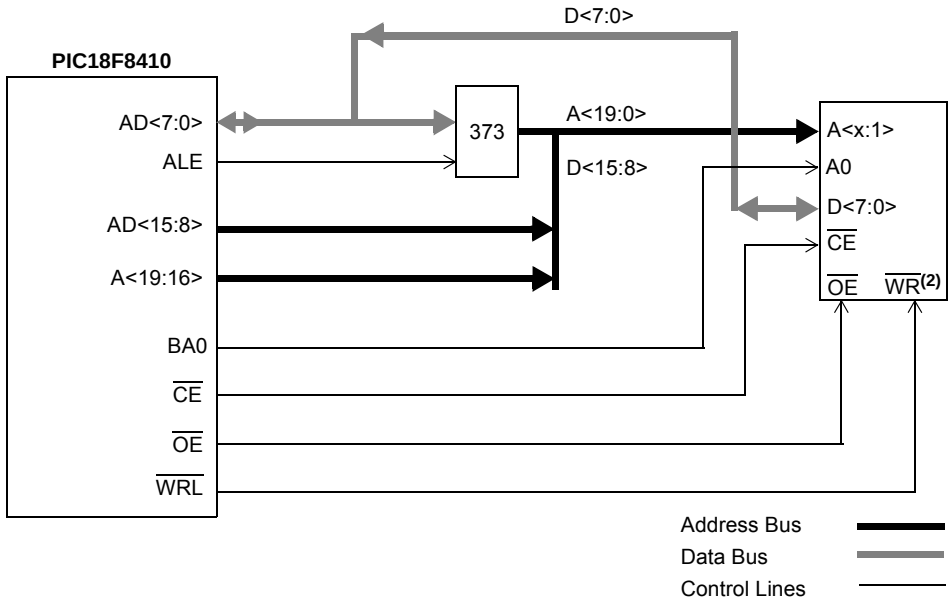
Figure 8-1 shows an example of 8-Bit Multiplexed mode for PIC18F8410 devices. This mode is used for a single 8-bit memory connected for 16-bit operation. The instructions will be fetched as two 8-bit bytes on a shared data/address bus. The two bytes are sequentially fetched within one instruction cycle (TCY). Therefore, the designer must choose external memory devices according to timing calculations based on 1/2 TCY (2 times the instruction rate). For proper memory speed selection, glue logic propagation delay times must be considered along with setup and hold times.

The Address Latch Enable (ALE) pin indicates that the address bits, A<15:0>, are available on the external memory interface bus. The Output Enable signal ($\overline{OE}$) will enable one byte of program memory for a portion of the instruction cycle, then BA0 will change and the second byte will be enabled to form the 16-bit instruction word. The Least Significant bit of the address, BA0, must be connected to the memory devices in this mode. The Chip Enable signal ($\overline{CE}$) is active at any time that the microcontroller accesses external memory, whether reading or writing; it is inactive (asserted high) whenever the device is in Sleep mode.

This generally includes basic EPROM and Flash devices. It allows table writes to byte-wide external memories.

During a TBLWT instruction cycle, the TABLAT data is presented on the upper and lower bytes of the AD<15:0> bus. The appropriate level of the BA0 control line is strobed on the LSb of the TBLPTR.

FIGURE 8-7: 8-BIT MULTIPLEXED MODE EXAMPLE



Note 1: Upper order address bits are used only for 20-bit address width. The upper AD byte is used for all address widths except 8-bit.

2: This signal only applies to table writes. See **Section 7.1 "Table Reads and Table Writes"**.

8.3.1 8-BIT MODE TIMING

The presentation of control signals on the external memory bus is different for the various operating modes. Typical signal timing diagrams are shown in Figure 8-4 through Figure 8-6.

FIGURE 8-8: EXTERNAL MEMORY BUS TIMING FOR TBLRD (MICROPROCESSOR MODE)

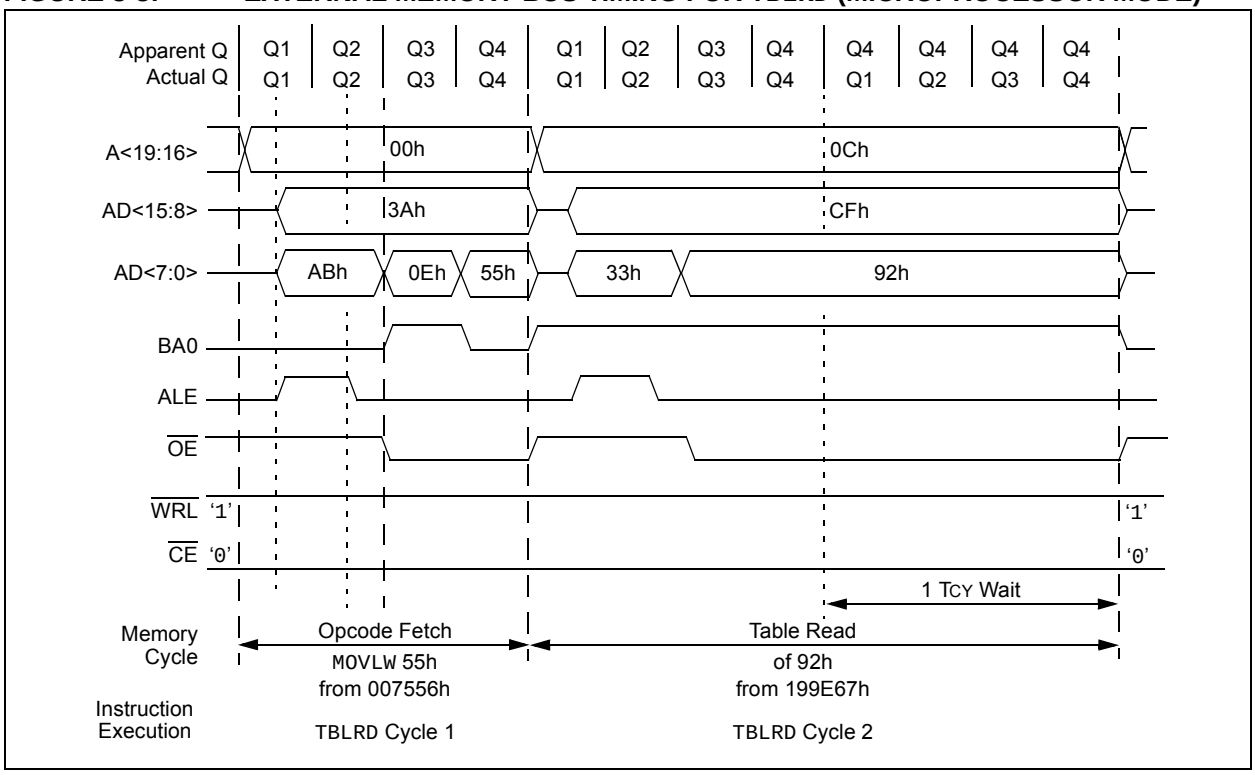


FIGURE 8-9: EXTERNAL MEMORY BUS TIMING FOR TBLRD (EXTENDED MICROCONTROLLER MODE)

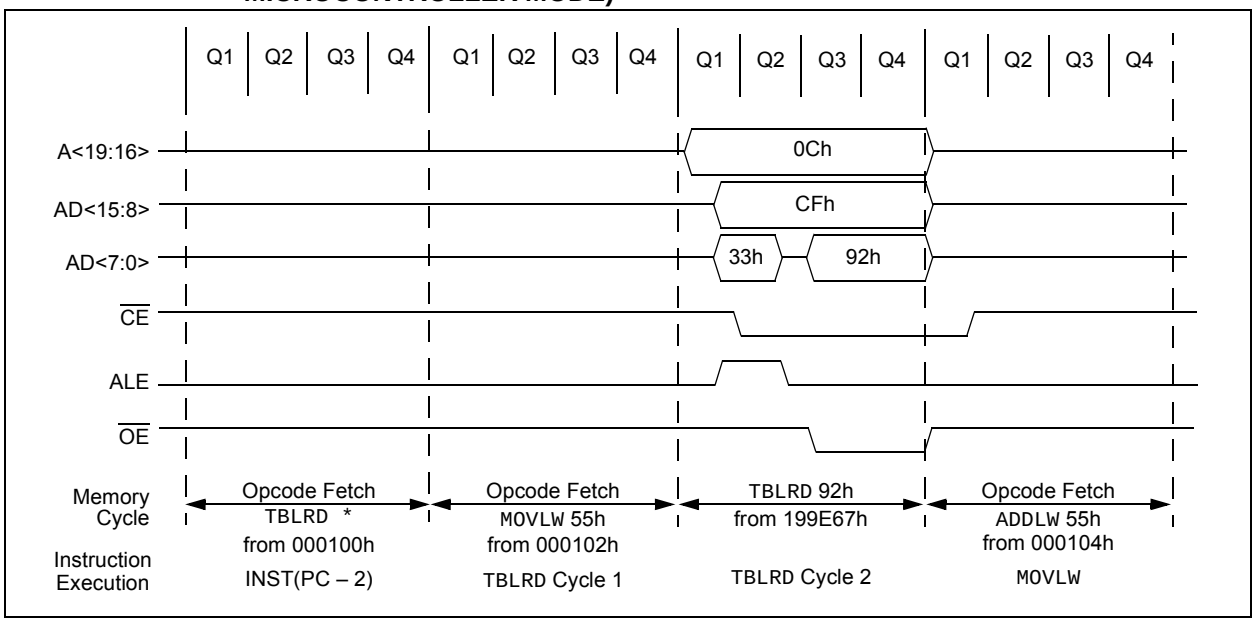


TABLE 11-7: PORTD FUNCTIONS

Pin Name	Function	TRIS Setting	I/O	I/O Type	Description
RD0/AD0/PSP0	RD0	0	O	DIG	LATD<0> data output.
		1	I	ST	PORTD<0> data input.
	AD0(2)	x	O	DIG	External memory interface, Address/Data Bit 0 output.(1)
		x	I	TTL	External memory interface, Data Bit 0 input.(1)
	PSP0	x	O	DIG	PSP read data output (LATD<0>); takes priority over port data.
		x	I	TTL	PSP write data input.
RD1/AD1/PSP1	RD1	0	O	DIG	LATD<1> data output.
		1	I	ST	PORTD<1> data input.
	AD1(2)	x	O	DIG	External memory interface, Address/Data Bit 1 output.(1)
		x	I	TTL	External memory interface, Data Bit 1 input.(1)
	PSP1	x	O	DIG	PSP read data output (LATD<1>); takes priority over port data.
		x	I	TTL	PSP write data input.
RD2/AD2/PSP2	RD2	0	O	DIG	LATD<2> data output.
		1	I	ST	PORTD<2> data input.
	AD2(2)	x	O	DIG	External memory interface, Address/Data Bit 2 output.(1)
		x	I	TTL	External memory interface, Data Bit 2 input.(1)
	PSP2	x	O	DIG	PSP read data output (LATD<2>); takes priority over port data.
		x	I	TTL	PSP write data input.
RD3/AD3/PSP3	RD3	0	O	DIG	LATD<3> data output.
		1	I	ST	PORTD<3> data input.
	AD3(2)	x	O	DIG	External memory interface, Address/Data Bit 3 output.(1)
		x	I	TTL	External memory interface, Data Bit 3 input.(1)
	PSP3	x	O	DIG	PSP read data output (LATD<3>); takes priority over port data.
		x	I	TTL	PSP write data input.
RD4/AD4/PSP4	RD4	0	O	DIG	LATD<4> data output.
		1	I	ST	PORTD<4> data input.
	AD4(2)	x	O	DIG	External memory interface, Address/Data Bit 4 output.(1)
		x	I	TTL	External memory interface, Data Bit 4 input.(1)
	PSP4	x	O	DIG	PSP read data output (LATD<4>); takes priority over port data.
		x	I	TTL	PSP write data input.
RD5/AD5/PSP5	RD5	0	O	DIG	LATD<5> data output.
		1	I	ST	PORTD<5> data input.
	AD5(2)	x	O	DIG	External memory interface, Address/Data Bit 5 output.(1)
		x	I	TTL	External memory interface, Data Bit 5 input.(1)
	PSP5	x	O	DIG	PSP read data output (LATD<5>); takes priority over port data.
		x	I	TTL	PSP write data input.
RD6/AD6/PSP6	RD6	0	O	DIG	LATD<6> data output.
		1	I	ST	PORTD<6> data input.
	AD6(2)	x	O	DIG-3	External memory interface, Address/Data Bit 6 output.(1)
		x	I	TTL	External memory interface, Data Bit 6 input.(1)
	PSP6	x	O	DIG	PSP read data output (LATD<6>); takes priority over port data.
		x	I	TTL	PSP write data input.

Legend: O = Output, I = Input, DIG = Digital Output, ST = Schmitt Buffer Input, TTL = TTL Buffer Input, x = Don't care (TRIS bit does not affect port direction or is overridden for this option).

Note 1: External memory interface I/O takes priority over all other digital and PSP I/O.

2: Implemented on 80-pin devices only.

11.7 PORTG, TRISG and LATG Registers

PORTG is a 6-bit wide, bidirectional port. The corresponding Data Direction register is TRISG. Setting a TRISG bit (= 1) will make the corresponding PORTG pin an input (i.e., put the corresponding output driver in a High-Impedance mode). Clearing a TRISG bit (= 0) will make the corresponding PORTG pin an output (i.e., put the contents of the output latch on the selected pin).

The Output Latch register (LATG) is also memory mapped. Read-modify-write operations on the LATG register, read and write the latched output value for PORTG.

PORTG is multiplexed with USART functions (Table 11-13). PORTG pins have Schmitt Trigger input buffers.

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTG pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings. The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register without concern due to peripheral overrides.

The sixth pin of PORTG (RG5/$\overline{\text{MCLR}}$/V_{PP}) is an input only pin. Its operation is controlled by the MCLRE Configuration bit. When selected as a port pin (MCLRE = 0), it functions as a digital input only pin; as such, it does not have TRIS or LAT bits associated with its operation. Otherwise, it functions as the device's Master Clear input. In either configuration, RG5 also functions as the programming voltage input during programming.

Note:	On a Power-on Reset, RG5 is enabled as a digital input only if Master Clear functionality is disabled. All other 5 pins are configured as digital inputs.

EXAMPLE 11-7: INITIALIZING PORTG

```
CLRF    PORTG   ; Initialize PORTG by
                ; clearing output
                ; data latches
CLRF    LATG    ; Alternate method
                ; to clear output
                ; data latches
MOVLW   0x04    ; Value used to
                ; initialize data
                ; direction
MOVWF   TRISG   ; Set RG1:RG0 as outputs
                ; RG2 as input
                ; RG4:RG3 as inputs
```

16.1 CCP Module Configuration

Each Capture/Compare/PWM module is associated with a control register (generically, CCPxCON) and a data register (CCPRx). The data register, in turn, is comprised of two 8-bit registers: CCPRxL (low byte) and CCPRxH (high byte). All registers are both readable and writable.

16.1.1 CCP MODULES AND TIMER RESOURCES

The CCP modules utilize Timers 1, 2 or 3, depending on the mode selected. Timer1 and Timer3 are available to modules in Capture or Compare modes, while Timer2 is available for modules in PWM mode.

TABLE 16-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1 or Timer3
Compare	Timer1 or Timer3
PWM	Timer2

The assignment of a particular timer to a module is determined by the Timer-to-CCP enable bits in the T3CON register (Register 15-1). All three modules may be active at any given time and may share the same timer resource if they are configured to operate in the same mode (Capture/Compare or PWM) at the same time.

Depending on the configuration selected, up to three timers may be active at once, with modules in the same configuration (Capture/Compare or PWM) sharing timer resources. The possible configurations are shown in Figure 16-1.

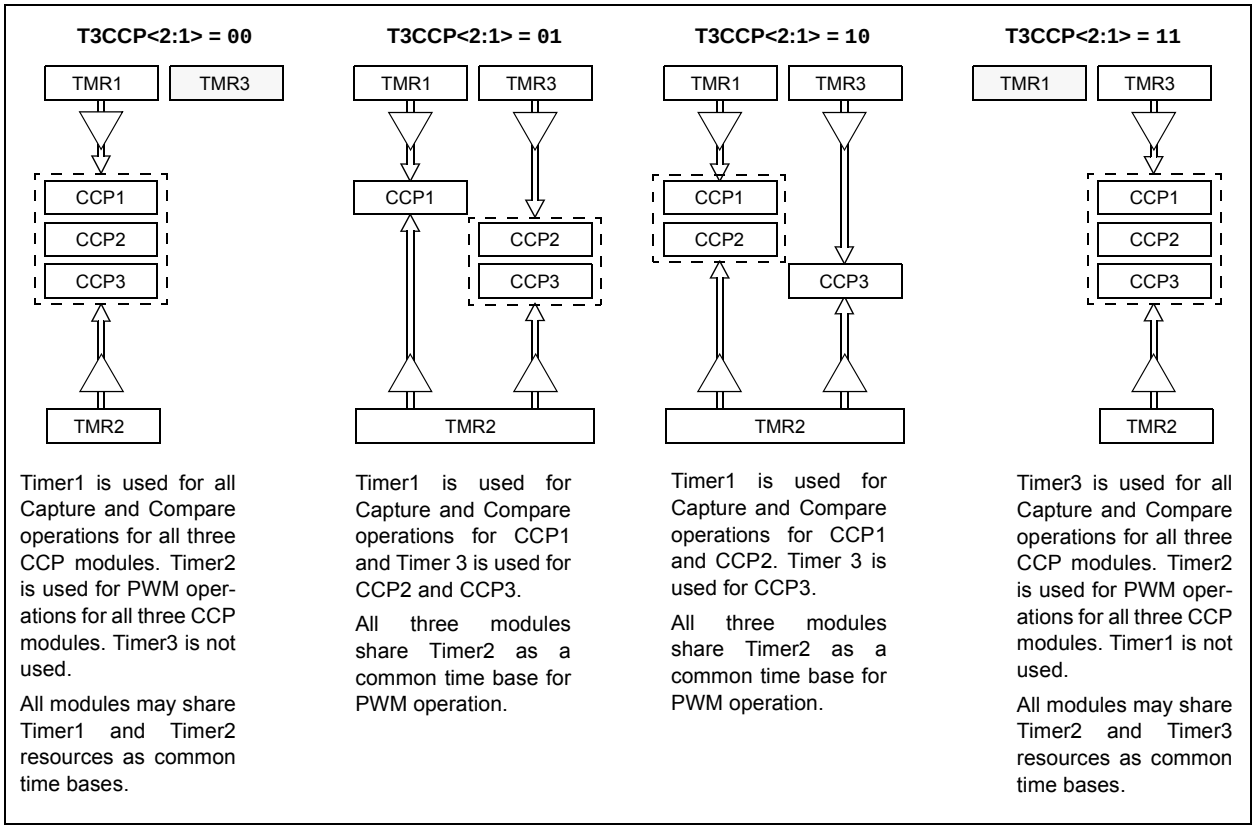
16.1.2 CCP2 PIN ASSIGNMENT

The CCP2MX Configuration bit determines if CCP2 is multiplexed to its default or alternate assignment. By default, CCP2 is assigned to RC1 (CCP2MX = 1). If CCP2MX is cleared, CCP2 is multiplexed with either RE7 or RB3 (RE7 is the only alternative assignment for 64-pin devices).

For any device in Microcontroller mode, the alternate CCP2 assignment is RE7. For 80-pin devices in Microcprocessor, Extended Microcontroller or Microcontroller with Boot Block mode, the alternate assignment is RB3. Note that RE7 is the only alternative assignment for 64-pin devices.

Changing the pin assignment of CCP2 does not automatically change any requirements for configuring the port pin. Users must always verify that the appropriate TRIS register is configured correctly for CCP2 operation, regardless of where it is located.

FIGURE 16-1: CCP AND TIMER INTERCONNECT CONFIGURATIONS



Timer1 is used for all Capture and Compare operations for all three CCP modules. Timer2 is used for PWM operations for all three CCP modules. Timer3 is not used.

All modules may share Timer1 and Timer2 resources as common time bases.

Timer1 is used for Capture and Compare operations for CCP1 and Timer 3 is used for CCP2 and CCP3.

All three modules share Timer2 as a common time base for PWM operation.

Timer1 is used for Capture and Compare operations for CCP1 and CCP2. Timer 3 is used for CCP3.

All three modules share Timer2 as a common time base for PWM operation.

Timer3 is used for all Capture and Compare operations for all three CCP modules. Timer2 is used for PWM operations for all three CCP modules. Timer1 is not used.

All modules may share Timer2 and Timer3 resources as common time bases.

TABLE 16-2: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1 AND TIMER3

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	63
RCON	IPEN	SBOREN	—	$\overline{RI}$	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$	64
PIR1	PSPIF	ADIF	RC1IF	TX1IF	SSPIF	CCP1IF	TMR2IF	TMR1IF	65
PIE1	PSPIE	ADIE	RC1IE	TX1IE	SSPIE	CCP1IE	TMR2IE	TMR1IE	65
IPR1	PSPIP	ADIP	RC1IP	TX1IP	SSPIP	CCP1IP	TMR2IP	TMR1IP	65
PIR2	OSCFIF	CMIF	—	—	BCLIF	HLVDIF	TMR3IF	CCP2IF	65
PIE2	OSCFIE	CMIE	—	—	BCLIE	HLVDIE	TMR3IE	CCP2IE	65
IPR2	OSCFIP	CMIP	—	—	BCLIP	HLVDIP	TMR3IP	CCP2IP	65
PIR3	—	—	RC2IF	TX2IF	—	—	—	CCP3IF	65
PIE3	—	—	RC2IE	TX2IE	—	—	—	CCP3IE	65
IPR3	—	—	RC2IP	TX2IP	—	—	—	CCP3IP	65
TRISB	PORTB Data Direction Register								66
TRISC	PORTC Data Direction Register								66
TRISE	PORTE Data Direction Register								66
TMR1L	Holding Register for the Least Significant Byte of the 16-Bit TMR1 Register								64
TMR1H	Holding Register for the Most Significant Byte of the 16-Bit TMR1 Register								64
T1CON	RD16	T1RUN	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{T1SYNC}$	TMR1CS	TMR1ON	64
TMR3H	Timer3 Register High Byte								65
TMR3L	Timer3 Register Low Byte								65
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	$\overline{T3SYNC}$	TMR3CS	TMR3ON	65
CCPR1L	Capture/Compare/PWM Register 1 (LSB)								65
CCPR1H	Capture/Compare/PWM Register 1 (MSB)								65
CCP1CON	—	—	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	65
CCPR2L	Capture/Compare/PWM Register 2 (LSB)								65
CCPR2H	Capture/Compare/PWM Register 2 (MSB)								65
CCP2CON	—	—	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	65
CCPR3L	Capture/Compare/PWM Register 3 (LSB)								65
CCPR3H	Capture/Compare/PWM Register 3 (MSB)								65
CCP3CON	—	—	DC3B1	DC3B0	CCP3M3	CCP3M2	CCP3M1	CCP3M0	65

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare, Timer1 or Timer3.

FIGURE 18-6: EUSART RECEIVE BLOCK DIAGRAM

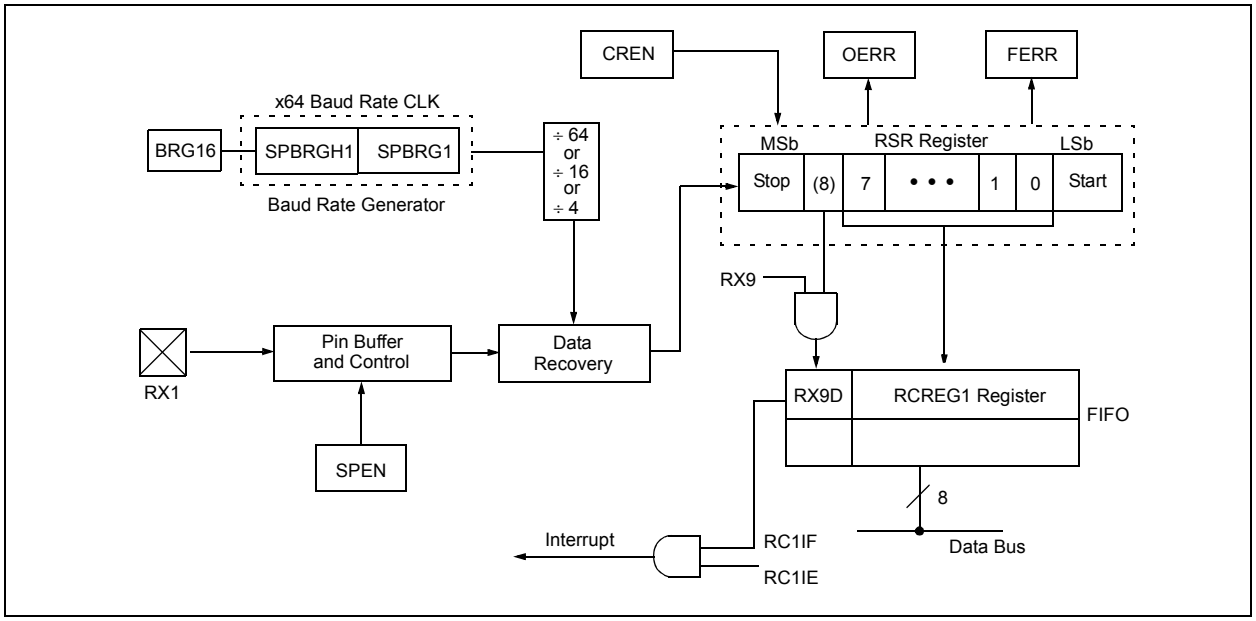
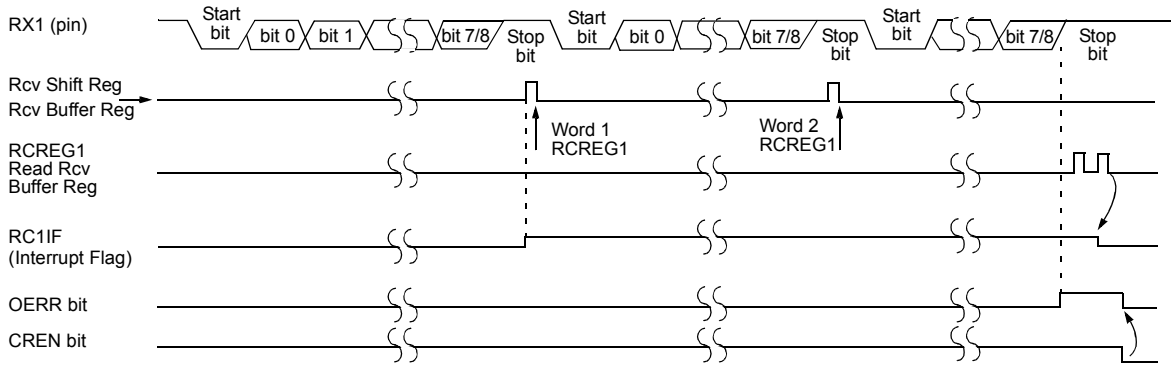


FIGURE 18-7: ASYNCHRONOUS RECEPTION



Note: This timing diagram shows three words appearing on the RX1 input. The RCREG1 (Receive Buffer) is read after the third word causing the OERR (Overrun) bit to be set.

FIGURE 18-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING NORMAL OPERATION

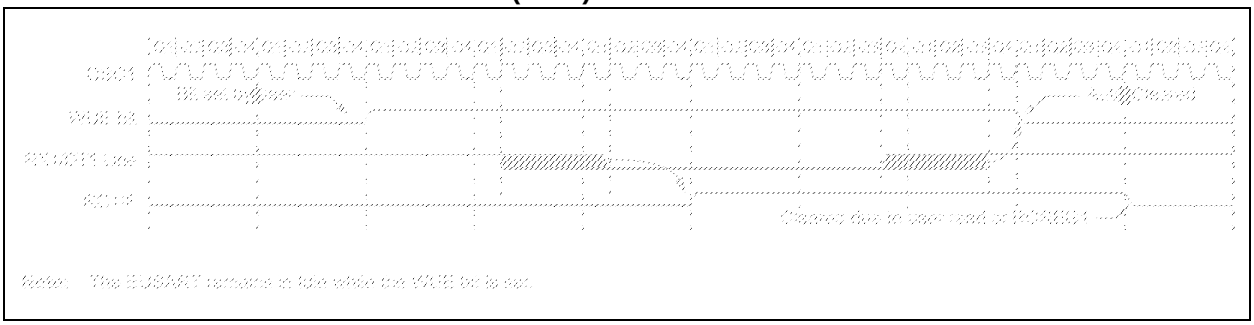
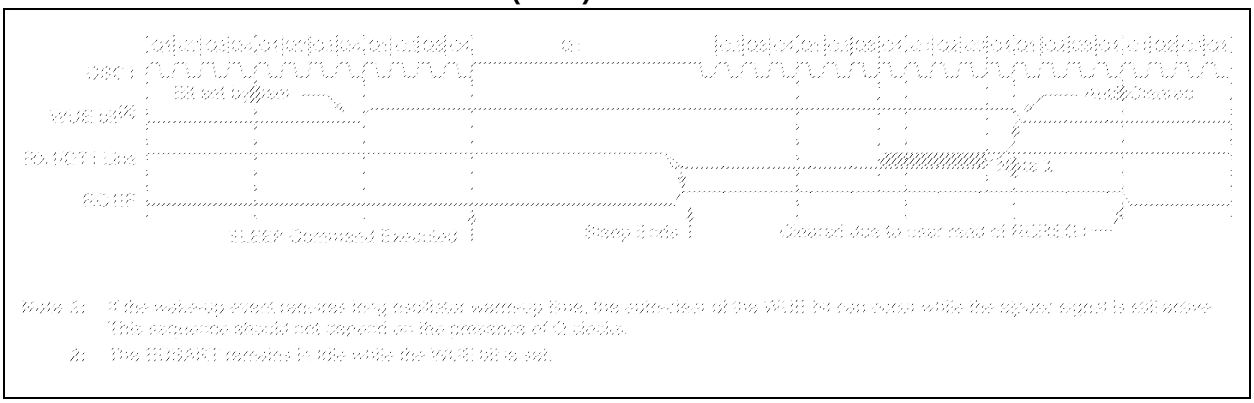


FIGURE 18-9: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP



23.0 HIGH/LOW-VOLTAGE DETECT (HLVD)

PIC18F6310/6410/8310/8410 devices have a High/Low-Voltage Detect module (HLVD). This is a programmable circuit that allows the user to specify both a device voltage trip point and the direction of change from that point. If the device experiences an excursion past the trip point in that direction, an interrupt flag is set. If the interrupt is enabled, the program execution will branch to the interrupt vector address and the software can then respond to the interrupt.

The High/Low-Voltage Detect Control register (Register 23-1) completely controls the operation of the HLVD module. This allows the circuitry to be "turned off" by the user under software control, which minimizes the current consumption for the device.

The block diagram for the HLVD module is shown in Figure 23-1.

REGISTER 23-1: HLVDCON: HIGH/LOW-VOLTAGE DETECT CONTROL REGISTER

R/W-0	U-0	R-0	R/W-0	R/W-0	R/W-1	R/W-0	R/W-1
VDIRMAG	—	IRVST	HLVDEN	HLVDL3(1)	HLVDL2(1)	HLVDL1(1)	HLVDL0(1)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **VDIRMAG:** Voltage Direction Magnitude Select bit
1 = Event occurs when voltage equals or exceeds trip point (HLVDL<3:0>)
0 = Event occurs when voltage equals or falls below trip point (HLVDL<3:0>)

bit 6 **Unimplemented:** Read as '0'

bit 5 **IRVST:** Internal Reference Voltage Stable Flag bit
1 = Indicates that the voltage detect logic will generate the interrupt flag at the specified voltage range
0 = Indicates that the voltage detect logic will not generate the interrupt flag at the specified voltage range and the HLVD interrupt should not be enabled

bit 4 **HLVDEN:** High/Low-Voltage Detect Power Enable bit
1 = HLVD is enabled
0 = HLVD is disabled

bit 3-0 **HLVDL<3:0>:** Voltage Detection Limit bits(1)
1110 = Maximum setting
•
•
•
0001 = Minimum setting

Note 1: HLVDL<3:0> modes that result in a trip point, below the valid operating voltage of the device, are not tested.

TABLE 25-2: PIC18FXXXX INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	16-Bit Instruction Word MSb LSb	Status Affected	Notes
BYTE-ORIENTED OPERATIONS						
ADDWF	f, d, a	Add WREG and f	1	0010 01da ffff ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010 00da ffff ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001 01da ffff ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110 101a ffff ffff	Z	2
COMF	f, d, a	Complement f	1	0001 11da ffff ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, Skip =	1 (2 or 3)	0110 001a ffff ffff	None	4
CPFSGT	f, a	Compare f with WREG, Skip >	1 (2 or 3)	0110 010a ffff ffff	None	4
CPFSLT	f, a	Compare f with WREG, Skip <	1 (2 or 3)	0110 000a ffff ffff	None	1, 2
DECF	f, d, a	Decrement f	1	0000 01da ffff ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010 11da ffff ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100 11da ffff ffff	None	1, 2
INCF	f, d, a	Increment f	1	0010 10da ffff ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011 11da ffff ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100 10da ffff ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1	0001 00da ffff ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101 00da ffff ffff	Z, N	1
MOVFF	f_s, f_d	Move f_s (source) to 1st word f_d (destination) 2nd word	2	1100 ffff ffff ffff 1111 ffff ffff ffff	None	
MOVWF	f, a	Move WREG to f	1	0110 111a ffff ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000 001a ffff ffff	None	1, 2
NEGF	f, a	Negate f	1	0110 110a ffff ffff	C, DC, Z, OV, N	
RLCF	f, d, a	Rotate Left f through Carry	1	0011 01da ffff ffff	C, Z, N	1, 2
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100 01da ffff ffff	Z, N	
RRCF	f, d, a	Rotate Right f through Carry	1	0011 00da ffff ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100 00da ffff ffff	Z, N	
SETF	f, a	Set f	1	0110 100a ffff ffff	None	1, 2
SUBFWB	f, d, a	Subtract f from WREG with Borrow	1	0101 01da ffff ffff	C, DC, Z, OV, N	
SUBWF	f, d, a	Subtract WREG from f	1	0101 11da ffff ffff	C, DC, Z, OV, N	1, 2
SUBWFB	f, d, a	Subtract WREG from f with Borrow	1	0101 10da ffff ffff	C, DC, Z, OV, N	
SWAPF	f, d, a	Swap Nibbles in f	1	0011 10da ffff ffff	None	4
TSTFSZ	f, a	Test f, Skip if 0	1 (2 or 3)	0110 011a ffff ffff	None	1, 2
XORWF	f, d, a	Exclusive OR WREG with f	1	0001 10da ffff ffff	Z, N	

Note 1: When a PORT register is modified as a function of itself (e.g., `MOVF PORTB, 1, 0`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned.

3: If the Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are two-word instructions. The second word of these instructions will be executed as a NOP, unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

5: Table write instructions are unavailable in 64-pin devices in normal operating modes. See **Section 7.4 "Writing to Program Memory Space (PIC18F8310/8410 only)"** and **Section 7.6 "Writing and Erasing On-Chip Program Memory (ICSP Mode)"** for more information.

ANDWF **AND W with f**

Syntax: ANDWF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: (W) .AND. (f) → dest

Status Affected: N, Z

Encoding:	0001	01da	ffff	ffff

Description: The contents of W are AND'ed with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.
If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 25.2.3** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: ANDWF REG, 0, 0

Before Instruction
W = 17h
REG = C2h
After Instruction
W = 02h
REG = C2h

BC **Branch if Carry**

Syntax: BC n

Operands: $-128 \le n \le 127$

Operation: if Carry bit is '1',
(PC) + 2 + 2n → PC

Status Affected: None

Encoding:	1110	0010	nnnn	nnnn

Description: If the Carry bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example: HERE BC 5

Before Instruction
PC = address (HERE)
After Instruction
If Carry = 1;
PC = address (HERE + 12)
If Carry = 0;
PC = address (HERE + 2)

BTG **Bit Toggle f**

Syntax: BTG f, b {,a}

Operands: $0 \le f \le 255$
$0 \le b < 7$
$a \in [0,1]$

Operation: $(\overline{f<b>}) \rightarrow f<b>$

Status Affected: None

Encoding:

0111	bbba	ffff	ffff

Description: Bit 'b' in data memory location 'f' is inverted.
If 'a' is '0', the Access Bank is selected.
If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 25.2.3** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BTG PORTC, 4, 0`

Before Instruction:
PORTC = 0111 0101 [75h]
After Instruction:
PORTC = 0110 0101 [65h]

BOV **Branch if Overflow**

Syntax: BOV n

Operands: $-128 \le n \le 127$

Operation: if Overflow bit is '1',
$(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

1110	0100	nnnn	nnnn

Description: If the Overflow bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BOV   Jump
Before Instruction
    PC          =   address (HERE)
After Instruction
    If Overflow =   1;
        PC      =   address (Jump)
    If Overflow =   0;
        PC      =   address (HERE + 2)
```

LFSR **Load FSR**

Syntax: LFSR f, k

Operands: $0 \le f \le 2$
$0 \le k \le 4095$

Operation: $k \rightarrow FSRf$

Status Affected: None

Encoding:

1110 1111	1110 0000	00ff $k_7$kkk	k_{11}kk kkkk

Description: The 12-bit literal 'k' is loaded into the file select register pointed to by 'f'.

Words: 2

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k' MSB	Process Data	Write literal 'k' MSB to FSRfH
Decode	Read literal 'k' LSB	Process Data	Write literal 'k' to FSRfL

Example: `LFSR 2, 3ABh`

After Instruction
FSR2H = 03h
FSR2L = ABh

MOVF **Move f**

Syntax: MOVF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: $f \rightarrow dest$

Status Affected: N, Z

Encoding:

0101	00da	ffff	ffff

Description: The contents of register 'f' are moved to a destination dependent upon the status of 'd'. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f'. Location 'f' can be anywhere in the 256-byte bank. If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See **Section 25.2.3** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write W

Example: `MOVF REG, 0, 0`

Before Instruction
REG = 22h
W = FFh
After Instruction
REG = 22h
W = 22h

26.2 MPLAB C Compilers for Various Device Families

The MPLAB C Compiler code development systems are complete ANSI C compilers for Microchip's PIC18, PIC24 and PIC32 families of microcontrollers and the dsPIC30 and dsPIC33 families of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

26.3 HI-TECH C for Various Device Families

The HI-TECH C Compiler code development systems are complete ANSI C compilers for Microchip's PIC family of microcontrollers and the dsPIC family of digital signal controllers. These compilers provide powerful integration capabilities, omniscient code generation and ease of use.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

The compilers include a macro assembler, linker, preprocessor, and one-step driver, and can run on multiple platforms.

26.4 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for PIC10/12/16/18 MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

26.5 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

26.6 MPLAB Assembler, Linker and Librarian for Various Device Families

MPLAB Assembler produces relocatable machine code from symbolic assembly language for PIC24, PIC32 and dsPIC devices. MPLAB C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- Support for the entire device instruction set
- Support for fixed-point and floating-point data
- Command line interface
- Rich directive set
- Flexible macro language
- MPLAB IDE compatibility

26.11 PICkit 2 Development Programmer/Debugger and PICkit 2 Debug Express

The PICkit™ 2 Development Programmer/Debugger is a low-cost development tool with an easy to use interface for programming and debugging Microchip's Flash families of microcontrollers. The full featured Windows® programming interface supports baseline (PIC10F, PIC12F5xx, PIC16F5xx), midrange (PIC12F6xx, PIC16F), PIC18F, PIC24, dsPIC30, dsPIC33, and PIC32 families of 8-bit, 16-bit, and 32-bit microcontrollers, and many Microchip Serial EEPROM products. With Microchip's powerful MPLAB Integrated Development Environment (IDE) the PICkit™ 2 enables in-circuit debugging on most PIC® microcontrollers. In-Circuit-Debugging runs, halts and single steps the program while the PIC microcontroller is embedded in the application. When halted at a breakpoint, the file registers can be examined and modified.

The PICkit 2 Debug Express include the PICkit 2, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

26.12 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at V_{DDMIN} and V_{DDMAX} for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an MMC card for file storage and data applications.

26.13 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

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